

## 74F373

Octal transparent latch (3-State)
74F374
Octal D flip-flop (3-State)

Product data<br>Supersedes data of 1994 Dec 05

PHILIPS

## Latch/flip-flop

## 74F373 Octal transparent latch (3-State)

 74F374 Octal D-type flip-flop (3-State)
## FEATURES

- 8-bit transparent latch — 74F373
- 8-bit positive edge triggered register - 74F374
- 3-State outputs glitch free during power-up and power-down
- Common 3-State output register
- Independent register and 3-State buffer operation
- SSOP Type II Package


## DESCRIPTION

The 74F373 is an octal transparent latch coupled to eight 3-State output devices. The two sections of the device are controlled independently by enable ( E ) and output enable ( OE ) control gates.

The data on the D inputs is transferred to the latch outputs when the enable ( E ) input is HIGH. The latch remains transparent to the data input while E is HIGH, and stores the data that is present one set-up time before the HIGH-to-LOW enable transition.

The 3-State output buffers are designed to drive heavily loaded 3-State buses, MOS memories, or MOS microprocessors.

The active-LOW output enable (OE) controls all eight 3-State buffers independent of the latch operation. When $\overline{O E}$ is LOW, latched or transparent data appears at the output.

When OE is HIGH, the outputs are in high impedance "off" state, which means they will neither drive nor load the bus.

The 74F374 is an 8-bit edge triggered register coupled to eight 3 -State output buffers. The two sections of the device are controlled independently by clock (CP) and output enable ( $\overline{\mathrm{OE}}$ ) control gates.

The register is fully edge triggered. The state of the D input, one set-up time before the LOW-to-HIGH clock transition is transferred to the corresponding flip-flop's Q output.
The 3-State output buffers are designed to drive heavily loaded 3-State buses, MOS memories, or MOS microprocessors.
The active-LOW output enable ( $\overline{\mathrm{OE}}$ ) controls all eight 3-State buffers independent of the register operation. When OE is LOW, the data in the register appears at the outputs. When OE is HIGH, the outputs are in high impedance "off" state, which means they will neither drive nor load the bus.

| TYPE | TYPICAL <br> PROPAGATION <br> DELAY | TYPICAL SUPPLY <br> CURRENT <br> (TOTAL) |
| :---: | :---: | :---: |
| 74 F 373 | 4.5 ns | 35 mA |


| TYPE | TYPICAL $\boldsymbol{f}_{\text {max }}$ | TYPICAL SUPPLY <br> CURRENT <br> (TOTAL) |
| :---: | :---: | :---: |
| 74 F 374 | 165 MHz | 55 mA |

ORDERING INFORMATION

| DESCRIPTION | ORDER CODE | PKG DWG \# |
| :---: | :---: | :---: |
|  | COMMERCIAL RANGE <br> $\mathrm{V}_{\mathrm{Cc}}=5 \mathrm{~V} \pm 10 \%, \mathrm{~T}_{\mathrm{amb}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |  |
|  | N74F373N, N74F374N | SOT146-1 |
| 20-pin plastic SOL | N74F373D, N74F374D | SOT163-1 |
| 20-pin plastic SSOP type II | N74F373DB, N74F374DB | SOT339-1 |

INPUT AND OUTPUT LOADING AND FAN OUT TABLE

| PINS | DESCRIPTION | $74 F($ U.L. $)$ <br> HIGH $/$ LOW | LOAD VALUE <br> HIGH/LOW |
| :---: | :--- | :---: | :---: |
| D0 - D7 | Data inputs | $1.0 / 1.0$ | $20 \mu \mathrm{AA} / 0.6 \mathrm{~mA}$ |
| E (74F373) | Enable input (active-HIGH) | $1.0 / 1.0$ | $20 \mu \mathrm{~A} / 0.6 \mathrm{~mA}$ |
| $\overline{\text { OE }}$ | Output enable inputs (active-LOW) | $1.0 / 1.0$ | $20 \mu \mathrm{~mA} / 0.6 \mathrm{~mA}$ |
| CP (74F374) | Clock pulse input (active rising edge) | $1.0 / 1.0$ | $20 \mu \mathrm{~A} / 0.6 \mathrm{~mA}$ |
| Q0 - Q7 | 3-State outputs | $150 / 40$ | $3.0 \mathrm{~mA} / 24 \mathrm{~mA}$ |

NOTE: One (1.0) FAST unit load is defined as: $20 \mu \mathrm{~A}$ in the HIGH state and 0.6 mA in the LOW state.

## PIN CONFIGURATION - 74F373

| OE 1 |  |
| :---: | :---: |
| Q0 2 | 19 Q7 |
| D0 3 | $18 \mathrm{D7}$ |
| D1 4 | 17 D 6 |
| Q1 5 | 16 Q6 |
| Q2 6 | 15 Q5 |
| D2 7 | 14 D5 |
| D3 8 | 13 D 4 |
| Q3 9 | 12 Q 4 |
| GND 10 | 11 E |
|  | 00250 |

LOGIC SYMBOL - 74F373


IEC/IEEE SYMBOL - 74F373


PIN CONFIGURATION - 74F374


IEC/IEE SYMBOL - 74F374

$V_{C C}=\operatorname{Pin} 20$ GND $=$ Pin 10

IEC/IEEE SYMBOL - 74F374


LOGIC DIAGRAM FOR 74F373


## LOGIC DIAGRAM FOR 74F374



FUNCTION TABLE FOR 74F373

| INPUTS |  |  | INTERNAL REGISTER | OUTPUTS | OPERATING MODE |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{\mathrm{OE}}$ | E | Dn |  | Q0-Q7 |  |
| L | H | L | L | L | Enable and read register |
| L | H | H | H | H |  |
| L | $\downarrow$ | 1 | L | L | Latch and read register |
| L | $\downarrow$ | h | H | H |  |
| L | L | X | NC | NC | Hold |
| H | L | X | NC | Z | Disable outputs |
| H | H | Dn | Dn | Z |  |

## NOTES:

$\mathrm{H}=$ High-voltage level
$h=$ HIGH state must be present one set-up time before the HIGH-to-LOW enable transition
L = Low-voltage level
I = LOW state must be present one set-up time before the HIGH-to-LOW enable transition
$\mathrm{NC}=$ No change
$X=$ Don't care
$Z=$ High impedance "off" state
$\downarrow=$ HIGH-to-LOW enable transition

FUNCTION TABLE FOR 74F374

| INPUTS |  |  | INTERNAL REGISTER | OUTPUTS | OPERATING MODE |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OE | CP | Dn |  | Q0 - Q7 |  |
| L | $\uparrow$ | I | L | L | Load and read register |
| L | $\uparrow$ | h | H | H |  |
| L | $\uparrow$ | X | NC | NC | Hold |
| H | $\uparrow$ | X | NC | Z | Disable outputs |
| H | $\uparrow$ | Dn | Dn | Z |  |

## NOTES:

H = High-voltage level
$h=$ HIGH state must be present one set-up time before the LOW-to-HIGH clock transition
L = Low-voltage level
I = LOW state must be present one set-up time before the LOW-to-HIGH clock transition
$\mathrm{NC}=$ No change
$X=$ Don't care
Z = High impedance "off" state
$\uparrow=$ LOW-to-HIGH clock transition
$\uparrow=$ Not LOW-to-HIGH clock transition

## ABSOLUTE MAXIMUM RATINGS

Operation beyond the limit set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free air temperature range.

| SYMBOL | PARAMETER | RATING | UNIT |
| :--- | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | -0.5 to +7.0 | V |
| $\mathrm{~V}_{\text {IN }}$ | Input voltage | -0.5 to +7.0 | V |
| $\mathrm{I}_{\mathrm{IN}}$ | Input current | -30 to +5 | mA |
| $\mathrm{~V}_{\text {OUT }}$ | Voltage applied to output in HIGH output state | -0.5 to $\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{I}_{\text {OUT }}$ | Current applied to output in LOW output state | 48 | mA |
| $\mathrm{~T}_{\text {amb }}$ | Operating free air temperature range | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

## RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | LIMITS |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | NOM | MAX |  |
| $\mathrm{V}_{\text {CC }}$ | Supply voltage | 4.5 | 5.0 | 5.5 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | 2.0 | - | - | V |
| $\mathrm{V}_{\mathrm{IL}}$ | LOW-level input voltage | - | - | 0.8 | V |
| $\mathrm{I}_{\mathrm{Ik}}$ | Input clamp current | - | - | -18 | mA |
| ${ }^{1} \mathrm{OH}$ | HIGH-level output current | - | - | -3 | mA |
| IOL | LOW-level output current | - | - | 24 | mA |
| $\mathrm{T}_{\text {amb }}$ | Operating free air temperature range | 0 | - | +70 | ${ }^{\circ} \mathrm{C}$ |

## DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

| SYMBOL | PARAMETER | TEST CONDITIONS ${ }^{1}$ |  | LIMITS |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP ${ }^{2}$ | MAX |  |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{~V}_{\mathrm{IL}}=\mathrm{MAX}, \\ & \mathrm{~V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OH}}=\mathrm{MAX} \end{aligned}$ | $\pm 10 \% \mathrm{~V}_{\mathrm{CC}}$ | 2.4 |  |  | V |
|  |  |  | $\pm 5 \% \mathrm{~V}_{\text {CC }}$ | 2.7 | 3.4 |  | V |
| $\mathrm{V}_{\text {OL }}$ | LOW-level output voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{~V}_{\mathrm{IL}}=\mathrm{MAX}, \\ & \mathrm{~V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=\mathrm{MAX} \end{aligned}$ | $\pm 10 \% \mathrm{~V}_{\text {cc }}$ |  | 0.35 | 0.50 | V |
|  |  |  | $\pm 5 \% \mathrm{~V}_{\text {CC }}$ |  | 0.35 | 0.50 | V |
| $\mathrm{V}_{\text {IK }}$ | Input clamp voltage | $\mathrm{V}_{\text {CC }}=\mathrm{MIN}, \mathrm{I}_{\mathrm{I}}=\mathrm{I}_{\mathrm{IK}}$ |  |  | -0.73 | -1.2 | V |
| I | Input current at maximum input voltage | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{1}=7.0 \mathrm{~V}$ |  |  |  | 100 | $\mu \mathrm{A}$ |
| $\mathrm{IIH}^{\text {l }}$ | High-level input current | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{1}=2.7 \mathrm{~V}$ |  |  |  | 20 | $\mu \mathrm{A}$ |
| IIL | Low-level input current | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{1}=0.5 \mathrm{~V}$ |  |  |  | -0.6 | mA |
| Iozh | Off-state output current, high-level voltage applied | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{O}}=2.7 \mathrm{~V}$ |  |  |  | 50 | $\mu \mathrm{A}$ |
| lozl | Off-state output current, low-level voltage applied | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ |  |  |  | -50 | $\mu \mathrm{A}$ |
| los | Short-circuit output current ${ }^{3}$ | $V_{C C}=M A X$ |  | -60 |  | -150 | mA |
| ICC | Supply current (total) | $\mathrm{V}_{C C}=\mathrm{MAX}$ |  |  | 35 | 60 | mA |
|  |  |  |  |  | 57 | 86 | mA |

## NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
2. All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time. For testing los, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, los tests should be performed last.

## AC ELECTRICAL CHARACTERISTICS

| SYMBOL | PARAMETER |  | TEST CONDITION | LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=+5.0 \mathrm{~V} \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} ; \mathrm{R}_{\mathrm{L}}=500 \Omega \\ \hline \end{gathered}$ | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=+5.0 \mathrm{~V} \pm 10 \% \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} ; \mathrm{R}_{\mathrm{L}}=500 \Omega \\ \hline \end{gathered}$ |  |  |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| $\begin{aligned} & \text { tpLH } \\ & t_{\text {PHL }} \end{aligned}$ | Propagation delay Dn to Qn | 74F373 |  | Waveform 3 | $\begin{aligned} & 3.0 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 5.3 \\ & 3.7 \end{aligned}$ | $\begin{aligned} & 7.0 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 8.0 \\ & 6.0 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpLH } \\ & \text { tpHL } \\ & \hline \end{aligned}$ | Propagation delay E to Qn |  |  | Waveform 2 | $\begin{aligned} & 5.0 \\ & 3.0 \end{aligned}$ | $\begin{aligned} & 9.0 \\ & 4.0 \end{aligned}$ | $\begin{gathered} 11.5 \\ 7.0 \end{gathered}$ | $\begin{aligned} & 5.0 \\ & 3.0 \end{aligned}$ | $\begin{gathered} 12.0 \\ 8.0 \end{gathered}$ | ns |
| $\begin{aligned} & \hline \mathrm{t}_{\text {PZH }} \\ & \mathrm{t}_{\text {PZL }} \end{aligned}$ | Output enable time to HIGH or LOW level |  | Waveform 6 Waveform 7 | $\begin{aligned} & 2.0 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 5.6 \\ & \hline \end{aligned}$ | $\begin{aligned} & 11.0 \\ & 7.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 2.0 \\ & \hline \end{aligned}$ | $\begin{gathered} 11.5 \\ 8.5 \\ \hline \end{gathered}$ | ns |
| $\begin{aligned} & \text { tphz } \\ & \text { tpLZ } \\ & \hline \end{aligned}$ | Output disable time from HIGH or LOW level |  | Waveform 6 Waveform 7 | $\begin{aligned} & 2.0 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 3.8 \end{aligned}$ | $\begin{aligned} & 6.5 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & \hline 2.0 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 7.0 \\ & 6.0 \end{aligned}$ | ns |
| $\mathrm{f}_{\text {max }}$ | Maximum clock frequency | 74F374 | Waveform 1 | 150 | 165 |  | 140 |  | ns |
| tpLH $t_{\text {PHL }}$ | Propagation delay CP to Qn |  | Waveform 1 | $\begin{aligned} & 3.5 \\ & 3.5 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 7.5 \\ & 7.5 \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 3.0 \end{aligned}$ | $\begin{aligned} & 8.5 \\ & 8.5 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpzH } \\ & \text { tpzL }^{2} \end{aligned}$ | Output enable time to HIGH or LOW level |  | Waveform 6 Waveform 7 | $\begin{aligned} & 2.0 \\ & 2.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 9.0 \\ & 5.3 \end{aligned}$ | $\begin{aligned} & \hline 11.0 \\ & 7.5 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 2.0 \\ & \hline \end{aligned}$ | $\begin{gathered} 12.0 \\ 8.5 \\ \hline \end{gathered}$ | ns |
| $\begin{aligned} & \text { tphz } \\ & \text { tpLz } \\ & \hline \end{aligned}$ | Output disable time from HIGH or LOW level |  | Waveform 6 Waveform 7 | $\begin{aligned} & 2.0 \\ & 2.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.3 \\ & 4.3 \\ & \hline \end{aligned}$ | $\begin{aligned} & 6.0 \\ & 5.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 2.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 7.0 \\ & 6.5 \\ & \hline \end{aligned}$ | ns |

## AC SET-UP REQUIREMENTS

| SYMBOL | PARAMETER |  | TEST CONDITION | LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=+5.0 \mathrm{~V} \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega \end{gathered}$ | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=+5.0 \mathrm{~V} \pm 10 \% \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega \\ \hline \end{gathered}$ |  |  |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{su}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{su}}(\mathrm{~L}) \end{aligned}$ | Set-up time, HIGH or LOW level Dn to E | 74F373 |  | Waveform 4 | $\begin{gathered} 0 \\ 1.0 \end{gathered}$ |  |  | $\begin{gathered} 0 \\ 1.0 \end{gathered}$ |  | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{h}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{h}}(\mathrm{~L}) \end{aligned}$ | Hold time, HIGH or LOW level Dn to E |  |  | Waveform 4 | $\begin{aligned} & 3.0 \\ & 3.0 \\ & \hline \end{aligned}$ |  |  | 3.0 3.0 |  | ns |
| $\mathrm{t}_{\mathrm{w}}(\mathrm{H})$ | E Pulse width, HIGH |  | Waveform 1 | 3.5 |  |  | 4.0 |  | ns |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{su}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{su}}(\mathrm{~L}) \end{aligned}$ | Set-up time, HIGH or LOW level Dn to CP | 74F374 | Waveform 5 | $\begin{aligned} & 2.0 \\ & 2.0 \end{aligned}$ |  |  | 2.0 2.0 |  | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{h}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{h}}(\mathrm{~L}) \\ & \hline \end{aligned}$ | Hold time, HIGH or LOW level Dn to CP |  | Waveform 5 | 0 |  |  | 0 |  | ns |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{w}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{w}}(\mathrm{~L}) \end{aligned}$ | CP Pulse width, HIGH or LOW |  | Waveform 5 | $\begin{aligned} & \hline 3.5 \\ & 4.0 \end{aligned}$ |  |  | 3.5 4.0 |  | ns |

## AC WAVEFORMS

For all waveforms, $\mathrm{V}_{\mathrm{M}}=1.5 \mathrm{~V}$.
The shaded areas indicate when the input is permitted to change for predictable output performance.


Waveform 1. Propagation delay for clock input to output, clock pulse widths, and maximum clock frequency


Waveform 4. Data set-up time and hold times

## AC WAVEFORMS (continued)

For all waveforms, $\mathrm{V}_{\mathrm{M}}=1.5 \mathrm{~V}$.
The shaded areas indicate when the input is permitted to change for predictable output performance.


Waveform 5. Data set-up time and hold times


Waveform 6. 3-State output enable time to HIGH level and output disable time from HIGH level


SF00264
Waveform 7. 3-State output enable time to LOW level and output disable time from LOW level

## TEST CIRCUIT AND WAVEFORMS




DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | $\mathrm{A}_{1}$ min. | $\mathrm{A}_{2}$ max. | b | $\mathrm{b}_{1}$ | c | $\mathrm{D}^{(1)}$ | $E^{(1)}$ | e | $\mathbf{e}_{1}$ | L | $\mathrm{M}_{\mathrm{E}}$ | $\mathrm{M}_{\mathrm{H}}$ | w | $\underset{\text { max. }}{Z^{(1)}}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 4.2 | 0.51 | 3.2 | $\begin{aligned} & 1.73 \\ & 1.30 \end{aligned}$ | $\begin{aligned} & 0.53 \\ & 0.38 \end{aligned}$ | $\begin{aligned} & 0.36 \\ & 0.23 \end{aligned}$ | $\begin{aligned} & 26.92 \\ & 26.54 \end{aligned}$ | $\begin{aligned} & 6.40 \\ & 6.22 \end{aligned}$ | 2.54 | 7.62 | $\begin{aligned} & 3.60 \\ & 3.05 \end{aligned}$ | $\begin{aligned} & 8.25 \\ & 7.80 \end{aligned}$ | $\begin{gathered} 10.0 \\ 8.3 \end{gathered}$ | 0.254 | 2.0 |
| inches | 0.17 | 0.020 | 0.13 | $\begin{aligned} & 0.068 \\ & 0.051 \end{aligned}$ | $\begin{aligned} & 0.021 \\ & 0.015 \end{aligned}$ | $\begin{aligned} & 0.014 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 1.060 \\ & 1045 \end{aligned}$ | $\begin{aligned} & 0.25 \\ & 0.24 \end{aligned}$ | 0.10 | 0.30 | $\begin{aligned} & 0.14 \\ & 0.12 \end{aligned}$ | $\begin{aligned} & 0.32 \\ & 0.31 \end{aligned}$ | $\begin{aligned} & 0.39 \\ & 0.33 \end{aligned}$ | 0.01 | 0.078 |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | EIAJ |  |  |
| SOT146-1 |  | MS-001 | SC-603 | - ¢ | $\begin{aligned} & -95-05-24 \\ & 99-12-27 \end{aligned}$ |



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | $\begin{gathered} \mathrm{A} \\ \max . \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $\mathrm{D}^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $L_{p}$ | Q | v | w | y | $z^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2.65 | $\begin{aligned} & 0.30 \\ & 0.10 \end{aligned}$ | $\begin{aligned} & 2.45 \\ & 2.25 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.49 \\ & 0.36 \end{aligned}$ | $\begin{aligned} & 0.32 \\ & 0.23 \end{aligned}$ | $\begin{aligned} & 13.0 \\ & 12.6 \end{aligned}$ | $\begin{aligned} & 7.6 \\ & 7.4 \end{aligned}$ | 1.27 | $\begin{aligned} & 10.65 \\ & 10.00 \end{aligned}$ | 1.4 | $\begin{aligned} & 1.1 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 1.1 \\ & 1.0 \end{aligned}$ | 0.25 | 0.25 | 0.1 | 0.9 0.4 | $\begin{aligned} & 8^{0} \\ & 0^{\circ} \end{aligned}$ |
| inches | 0.10 | $\begin{aligned} & 0.012 \\ & 0.004 \end{aligned}$ | $\begin{aligned} & 0.096 \\ & 0.089 \end{aligned}$ | 0.01 | $\begin{aligned} & 0.019 \\ & 0.014 \end{aligned}$ | $\begin{aligned} & 0.013 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.51 \\ & 0.49 \end{aligned}$ | $\begin{aligned} & 0.30 \\ & 0.29 \end{aligned}$ | 0.050 | $\begin{aligned} & 0.419 \\ & 0.394 \end{aligned}$ | 0.055 | $\begin{aligned} & 0.043 \\ & 0.016 \end{aligned}$ | $\begin{aligned} & 0.043 \\ & 0.039 \end{aligned}$ | 0.01 | 0.01 | 0.004 | $\begin{aligned} & 0.035 \\ & 0.016 \end{aligned}$ |  |

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  | EUROPEAN | ISSUE DATE |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  | PROJECTION | EIAJ |  |  |  |  |
| SOT163-1 | $075 E 04$ | JEDEC | MS-013 |  |  | $-97-05-22$ |



DIMENSIONS ( mm are the original dimensions)

| UNIT | $\mathbf{A}$ <br> $\mathbf{m a x}$. | $\mathbf{A}_{\mathbf{1}}$ | $\mathbf{A}_{\mathbf{2}}$ | $\mathbf{A}_{\mathbf{3}}$ | $\mathbf{b}_{\mathbf{p}}$ | $\mathbf{c}$ | $\mathbf{D}^{(1)}$ | $\mathbf{E}^{(1)}$ | $\mathbf{e}$ | $\mathbf{H}_{\mathbf{E}}$ | $\mathbf{L}$ | $\mathbf{L}_{\mathbf{p}}$ | $\mathbf{Q}$ | $\mathbf{v}$ | $\mathbf{w}$ | $\mathbf{y}$ | $\mathbf{Z}^{(1)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2.0 | 0.21 | 1.80 | 0.25 | 0.38 | 0.20 | 7.4 | 5.4 | 0.65 | 7.9 | 1.25 | 1.03 | 0.9 | 0.2 | 0.13 | 0.1 | 0.9 |
|  | 0.05 | 1.65 | 0.25 | 0.09 | 7.0 | 5.2 | 0.65 | 7.6 | $8^{0}$ |  |  |  |  |  |  |  |  |
| 0.25 | 0.63 | 0.7 | 0.2 | $0^{0}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | EIAJ |  |  |
| SOT339-1 |  | MO-150 |  | $\square$ (+) | $\begin{aligned} & -95-02-04 \\ & 99-12-27 \end{aligned}$ |

## REVISION HISTORY

| Rev | Date | Description |
| :--- | :--- | :--- |
| $\_3$ | 20021120 | Product data; third version (9397 750 10758). Supersedes 74F373_374_2 dated 1994 Dec 05 <br> (9397 750 05119). <br> Engineering Change Notice 853-0369 29206 (date: 20021115). <br> Modifications: <br> $\bullet$ <br> Corrected ordering information table (from 'N74374DB' to ‘74F374DB'). <br> $\bullet$ <br> $\bullet$ |
| $\_2$ | 19941205 | Product SSOP20 (SOT339-1) package outline drawing. <br> Engineering Change Notice 853-0369 14383 (date: 19941205). |

## Data sheet status

| Level | Data sheet status [1] | Product <br> status ${ }^{[2] ~[3] ~}$ | Definitions |
| :--- | :--- | :--- | :--- |
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. <br> Philips Semiconductors reserves the right to change the specification in any manner without notice. |
| II | Preliminary data | Qualification | This data sheet contains data from the preliminary specification. Supplementary data will be published <br> at a later date. Philips Semiconductors reserves the right to change the specification without notice, in <br> order to improve the design and supply the best possible product. |
| III | Product data | Production | This data sheet contains data from the product specification. Philips Semiconductors reserves the <br> right to make changes at any time in order to improve the design, manufacturing and supply. Relevant <br> changes will be communicated via a Customer Product/Process Change Notification (CPCN). |

[1] Please consult the most recently issued data sheet before initiating or completing a design.
[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

## Definitions

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.
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